| L Number | Hits | Search Text | DB | Time stamp |
|---|---|---|---|---|
| 1 | 106 | soi and (vertical with interconnect) and field and (substrate with (etch$3 or remov$3)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/25 15:04 |
| 2 | 45 | (soi and (vertical with interconnect) and field and (substrate with (etch$3 or remov$3))) and @ad<19990423 | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/25 15:04 |
| - | 0 | soi and ((via hole open$3 contact) with fox) and (thin$4 with backside with substrate) and (backside with (connection or contact)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/25 14:54 |
| - | 124 | soi and (via hole open$3 contact) and (thin$4 with substrate) and (backside with (connection or contact)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/24 14:39 |
| - | 75 | (soi and (via hole open$3 contact) and (thin$4 with substrate) and (backside with (connection or contact))) and @ad<19990423 | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/24 14:41 |
| - | 69 | soi and (via hole open$3 contact) and (backside with etch$3) and (backside with (connection or contact)) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/24 14:54 |
| - | 41 | (soi and (via hole open$3 contact) and (backside with etch$3) and (backside with (connection or contact))) and @ad<19990423 | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/24 15:00 |
| - | 36 | (form$3 with (via hole open$3 contact) with (field adj oxide)) and (backside with etch$3) | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/24 14:58 |
| - | 25 | ((form$3 with (via hole open$3 contact) with (field adj oxide)) and (backside with etch$3) ) and @ad<19990423 | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/24 15:23 |
| - | 2 | 5426072.pn. | USPAT; US-PGPUB; EPO; JPO; DERWENT | 2003/04/24 15:23 |